MiniDIN Series (SSV-G)

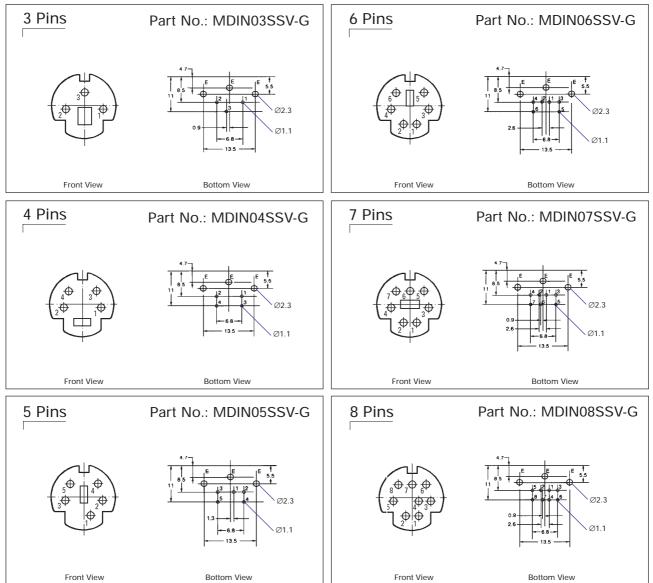
Specifications

Insulation Resistance: Withstanding Voltage: Contact Resistance: Rating:	50MΩ min 250V AC for 1 minute 30mΩ max. 1A max. at 10V AC 2A max. at 12V DC	
Operating Temp Range: Mating Cycles:	-55°C to +85°C 1000 min. at 10-20 times per minute (no electrical load)	
Soldering Temp.:	230°C / 3 sec.	
Materials and Fin Housing: Thermoplastic Contact: Phosphor Bro Plating: Selective Gold	nze RoHS	4.7 5.5 8.5 2.5

Features

 \doteqdot 90° Pin Through Hole Receptacle, with shielding and 4 grounding springs \doteqdot Selective gold plating

Contact Arrangements and PCB Layouts



Trading Division

SPECIFICATIONS AND DRAWINGS ARE SUBJECT TO ALTERATION WITHOUT PRIOR NOTICE - DIMENSIONS IN MILLIMETER Sockets and Connectors